

General Description

The MAX4634 fast, low-voltage, 4-channel CMOS analog multiplexer features 4Ω (max) on-resistance (RoN). It offers R_{ON} matching between switches to 0.3Ω (max) and RON flatness of 1Ω (max) over the specified signal range. Each switch can handle V+ to GND analog signals. Off-leakage current is only 0.1nA (max) at +25°C. The MAX4634 features fast turn-on (ton) and turn-off (tOFF) times of 18ns and 11ns, respectively. All this comes in the tiny 10-pin µMAX and 10-pin, 3mm x 3mm, thin QFN packages.

This low-voltage multiplexer operates from a +1.8V to +5.5V single supply. All digital inputs have +0.8V and +2.4V logic thresholds, ensuring TTL/CMOS-logic compatibility with +5V operation.

Applications

Battery-Operated Equipment Audio and Video Signal Routing Low-Voltage Data-Acquisition Systems Sample-and-Hold Circuits Communications Circuits

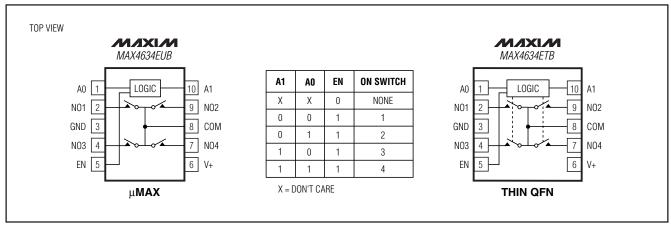
Features

- ♦ Guaranteed Ron 2.5 Ω (typ) with 5V Supply 4.5 Ω (typ) with 3V Supply
- ♦ 0.3Ω (max) Guaranteed Ron Match Between Channels
- ♦ 1Ω (max) Guaranteed Ron Flatness Over Signal Range
- ♦ 0.1nA (at +25°C) Guaranteed Low Leakage Currents
- ♦ +1.8V to +5.5V Single-Supply Operation
- ♦ +1.8V Operation $R_{ON} = 30\Omega$ (typ) Over Temperature $t_{ON} = 30$ ns (typ), $t_{OFF} = 13$ ns (typ)
- ♦ V+ to GND Signal Handling
- **♦ TTL/CMOS-Logic Compatible**
- ◆ -78dB Crosstalk (at 1MHz)
- ♦ -80dB Off-Isolation (at 1MHz)
- ♦ 0.018% Total Harmonic Distortion

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4634EUB	-40°C to +85°C	10 μMAX	_
МАХ4634ЕТВ	-40°C to +85°C	10 Thin QFN (3mm x 3mm)	AAU

Pin Configuration/Functional Diagram/Truth Table



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND)	
V+	0.3V to +6V
A_, EN, COM, NO_ (Note 1)	0.3V to $(V + + 0.3V)$
Continuous Current (all other pins)	±20mA
Continuous Current (COM, NO_)	±50mA
Peak Current (COM, NO_ pulsed at 1ms,	
10% duty cycle)	±100mA

Continuous Power Dissipation ($T_A = +7$	0°C)
10-Pin µMAX (derate 4.1mW/°C above	ve +70°C)330mW
10-Pin Thin QFN (derate 24.4mW/°C	
above +70°C)	1951mW
Operating Temperature Range	
MAX4634EUB	40°C to +85°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Note 1: Signals on NO_, COM, EN, or A_ exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Single +5V Supply

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=2.4V, V_{IL}=0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at V+ = +5V, T_A=+25^{\circ}\text{C}.) (Notes 2, 9)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH	1						
Analog Signal Range	V _{COM} , V _{NO} _			0		V+	V
On-Resistance	Pou	$V + = 4.5V,$ $I_{COM} = 10mA,$	T _A = +25°C		2.5	4	Ω
On-nesistance	RON	$V_{NO} = 0 \text{ to V} +$	$T_A = T_{MIN}$ to T_{MAX}			4.5	22
On-Resistance Match Between Channels	4D	V+ = 4.5V,	T _A = +25°C		0.1	0.3 0.4	0
(Notes 3, 8)	ΔR _{ON}	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	$T_A = T_{MIN}$ to T_{MAX}				52
On-Resistance Flatness	D	V+ = 4.5V,	T _A = +25°C		0.75	1	0
(Note 4)	RFLAT(ON)	$I_{COM} = 10mA,$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			1.2	Ω
NO_ Off-Leakage	1	V+ = 5.5V; V _{COM} = 1V, 4.5V; V _{NO} = 4.5V, 1V	T _A = +25°C	-0.1	±0.01	0.1	A
Current (Note 5)	INO_(OFF)		TA = TMIN to TMAX	-0.3		0.3	nA
COM Off-Leakage Current	leer veets	V+ = 5.5V;	T _A = +25°C	-0.1	±0.01	0.1	A
(Note 5)	ICOM(OFF)	$V_{COM} = 1V, 4.5V;$ $V_{NO} = 4.5V, 1V$	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	nA
COM On-Leakage Current		V+ = 5.5V; $V_{COM} = 1V, 4.5V;$	T _A = +25°C	-0.1	±0.01	0.1	nA
(Note 5)	ICOM(ON)	$\begin{array}{c c} ICOM(ON) & VCOM = 1V, 4.5V, \\ V_{NO} = 1V, 4.5V, \\ or floating & T_A = T_{MIN} \text{ to } T_{MAX} \end{array}$	TA = TMIN to TMAX	-0.65		0.65	ΠA
DIGITAL I/O (A_, EN)		I					
Input Logic High	V _{IH}			2.4			V
Input Logic Low	V _{IL}					0.8	V
Input Logic Current				-100	5	100	nA

ELECTRICAL CHARACTERISTICS—Single +5V Supply (continued)

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=2.4V, V_{IL}=0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+5V, T_A=+25^{\circ}\text{C}$.) (Notes 2, 9)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DYNAMIC							
Turn-On Time (Note 5)	ton	$V_{NO} = 3V$, $R_{I} = 300\Omega$,	T _A = +25°C		14	18	ns
rum on time (Note 3)	TON	$C_L = 35pF$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			20	115
Turn-Off Time (Note 5)	toff	$V_{NO_{-}} = 3V,$ $R_{I} = 300\Omega,$	T _A = +25°C		6	11	
rum-on time (Note 3)	OFF	C _L = 35pF, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			13	ns
Break-Before-Make Time	tbbm	$V_{NO_{-}} = 3V,$ $R_{1} = 300\Omega,$	T _A = +25°C		8		- ns
(Note 5)	rBBIM	C _L = 35pF, Figure 3	TA = TMIN to TMAX	1			
Charge Injection	Q	V _{GEN} = 2V, R _{GEN} = 0,	V _{GEN} = 2V, R _{GEN} = 0, C _L = 5pF, Figure 4		2		рС
Off-Isolation (Note 6)	V _{ISO}	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-57		dB
On-isolation (Note o)	V150	Figure 5	f = 1MHz		-80		l ab
Crosstalk (Note 7)	VCT	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-52		dB
Crossiaik (Note 1)	VCI	Figure 5	f = 1MHz		-78		ub
NO_ Off-Capacitance	C _{NO_(OFF)}	Figure 6			13		pF
COM Off-Capacitance	CCOM(OFF)	Figure 6			52		рF
COM On-Capacitance	CCOM(ON)	C _L = 5pF, Figure 6			68		рF
Total Harmonic Distortion	THD	$R_L = 600\Omega$, $f = 20Hz$ to	20kHz		0.018		%
POWER SUPPLY	•			•			•
Power-Supply Range	V+			1.8		5.5	V
Positive Supply Current	I+	V+ = 5.5V, V _I H = V+, V	/IL = 0		0.001	1.0	μΑ

ELECTRICAL CHARACTERISTICS—Single +3V Supply

 $(V+=+2.7V \text{ to } +3.3V, V_{\text{IH}}=2.0V, V_{\text{IL}}=0.4V, T_{\text{A}}=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_{\text{A}}=+25^{\circ}\text{C}.)$ (Notes 2, 9)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH	•						
Analog Signal Range	V _{COM_} , V _{NO_}			0		V+	V
On-Resistance	Bon	V+ = 2.7V,	T _A = +25°C		4.5	7	Ω
On-niesistance	RON $ COM = 10 \text{mA}, $ $V_{NO} = 0 \text{ to V} + $ $ T_A = T_{MIN} \text{ to T}_{MAX} $			8	32		
On-Resistance Match Between Channels	ΔRon	V+ = 2.7V,	T _A = +25°C		0.1	0.3	Ω
(Notes 3, 8)	Δι 1()(V	$I_{COM} = 10\text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			0.4	22

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at V+ = +3V, T_A=+25^{\circ}\text{C}.) (Notes 2, 9)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
On-Resistance Flatness	D	V+ = 2.7V,	TA = +25°C		1.2	2.5	0
(Note 4)	RFLAT(ON)	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			3	Ω
NO_ Off-Leakage Current	lue (ess)	V+ = 3.3V;	T _A = +25°C	-0.1	±0.01	0.1	nA
(Note 5)	INO_(OFF)	$V_{COM} = 1V, 3V;$ $V_{NO} = 3V, 1V$	TA = TMIN to TMAX	-0.3		0.3	
COM Off-Leakage Current	loon (off)	V+ = 3.3V; V _{COM} = 1V, 3V;	T _A = +25°C	-0.1	±0.01	0.1	nA
(Note 5)	ICOM_(OFF)	V _{NO} = 3V, 1V	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	
COM On-Leakage Current	1	V+ = 3.3V; V _{COM} = 1V, 3V;	T _A = +25°C	-0.1	±0.01	0.1	0
(Note 5)	ICOM_(ON)	V _{NO} __ = 1V, 3V, or floating	TA = TMIN to TMAX	-0.65		0.65	- nA
DIGITAL I/O (A_, EN)							
Input High	V _{IH}			2.0			V
Input Low	VIL					0.4	V
Input Logic Current				-100	5	100	nA
DYNAMIC							
Turn-On Time (Note 5)	ton	$V_{NO} = 2V,$ $C_1 = 35pF,$	T _A = +25°C		16	22	ns
rum-on nine (Note 3)	TON	$R_L = 300\Omega$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			24	1 115
Turn-Off Time (Note 5)	toff	$V_{NO_{-}} = 2V,$ $C_{1} = 35pF,$	T _A = +25°C		8	14	ns
rum-on time (Note 3)	UFF	$R_L = 300\Omega$, Figure 2	TA = TMIN to TMAX			16	113
Break-Before-Make Time	tbbm	V _{NO} _ = 2V, C _L = 35pF,	T _A = +25°C		9		ns
(Note 5)	IBBINI	$R_L = 300\Omega$, Figure 3	$T_A = T_{MIN}$ to T_{MAX}	1			115
Charge Injection	Q	V _{GEN} = 1.5V, R _{GEN} = 0	0, C _L = 5pF, Figure 4		2		рС
Off-Isolation (Note 6)	Viso	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-57		dB
On rediction (Note o)	V15U	Figure 5	f = 1MHz		-80		UD.
Crosstalk (Note 7)	V _{CT}	$C_L = 5pF$, $R_L = 50\Omega$,	f = 10MHz		-52		dB
5.500tain (110to 1)	•01	Figure 5	f = 1MHz		-78		— ub

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

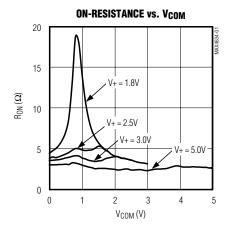
 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}\text{C}$.) (Note 2)

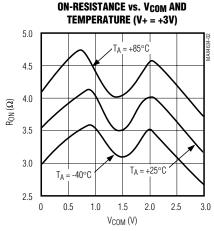
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
NO_ Off-Capacitance	CNO_(OFF)	V _{NO} _ = GND, f = 1MHz, Figure 6		13		pF
COM Off-Capacitance	CCOM(OFF)	V _{COM} = GND, f = 1MHz, Figure 6		52		рF
COM On-Capacitance	C _(ON)	V _{COM} = V _{NO} = GND, f = 1MHz, Figure 6		68		pF
Total Harmonic Distortion	THD	$R_L = 600\Omega$, $f = 20Hz$ to $20kHz$		0.018		%
POWER SUPPLY	•					
Positive Supply Current	I+	$V+ = 3.3V$, $V_{IH} = V+$, $V_{IL} = 0$		0.001	1	μΑ

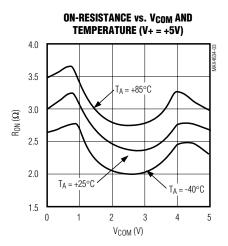
- **Note 2:** The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.
- **Note 3:** $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$.
- **Note 4:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- Note 5: Guaranteed by design.
- Note 6: Off-Isolation = $20log_{10}$ (V_{COM} / V_{NO}), where V_{COM} = output and V_{NO} = input to off switch.
- Note 7: Between any two switches.
- **Note 8:** R_{ON} and ΔR_{ON} matching specifications for QFN-packaged parts are guaranteed by design.
- Note 9: Thin QFN parts are tested at +25°C and guaranteed by design and correlation over the entire temperature range.

Typical Operating Characteristics

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

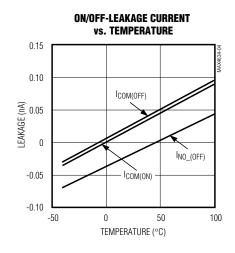




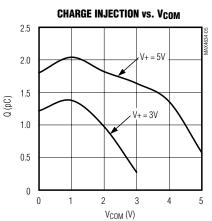


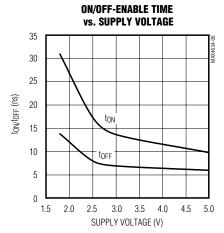
Typical Operating Characteristics (continued)

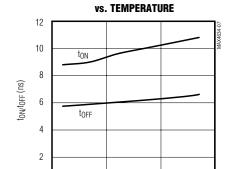
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



0 **└** -50







0

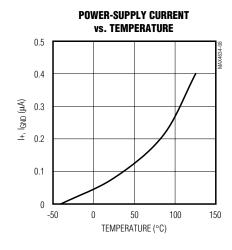
TEMPERATURE (°C)

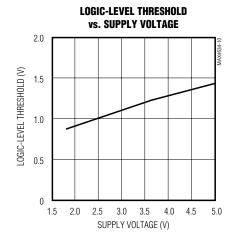
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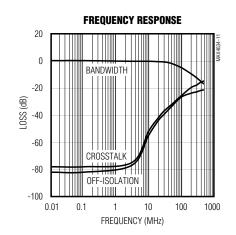
100

ON/OFF-ENABLE TIME









Pin Description

PIN		
μΜΑΧ/ THIN QFN	NAME	FUNCTION
1	A0	Address Input
2	NO1	Normally Open Switch 1
3	GND	Ground
4	NO3	Normally Open Switch 3
5	EN	Enable Logic Input
6	V+	Positive Supply Voltage
7	NO4	Normally Open Switch 4
8	COM	Analog Switch Common Terminal
9	NO2	Normally Open Switch 2
10	A1	Address Input

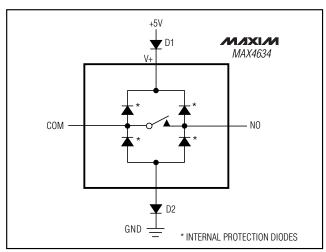


Figure 1. Overvoltage Protection Using External Blocking Diodes

Detailed Description

The MAX4634 is a low-on-resistance, low-voltage analog multiplexer that operates from a +1.8V to +5.5V single supply. CMOS switch construction allows processing of analog signals that are within the supply voltage range (GND to V+).

To disable all switch channels, drive EN low. All four inputs and COM become high impedance during this state. If the disable feature is not needed, connect EN to V+.

Applications Information

Power-Supply Sequencing and Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals or logic inputs, especially if the analog or

logic signals are not current limited. If this sequencing is not possible, and if the analog or logic inputs are not current limited to < 20mA, add a small-signal diode (D1) as shown in Figure 1. If the analog signal can dip below GND, add D2. Adding protection diodes reduces the analog signal range to a diode drop (about 0.7V) below V+ for D1 or to a diode drop above ground for D2. The addition of diodes does not affect leakage. Onresistance increases by a small amount at low supply voltages. Maximum supply voltage (V+) must not exceed 6V.

Protection diodes D1 and D2 also protect against some overvoltage situations. A fault voltage up to the absolute maximum rating at an analog signal input does not damage the device, even if the supply voltage is below the signal voltage.

Test Circuits/Timing Diagrams

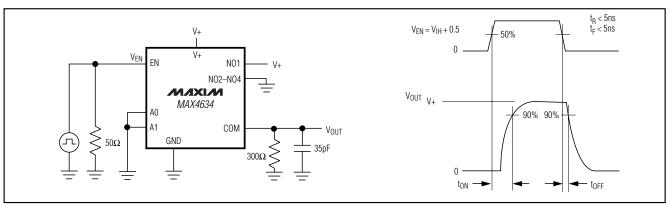


Figure 2. Switching Time

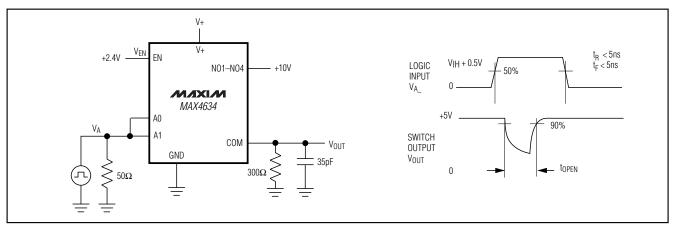


Figure 3. Break-Before-Make Interval

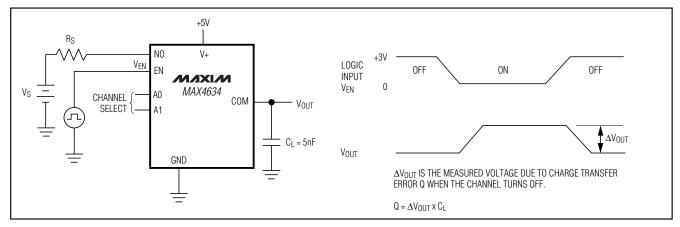


Figure 4. Charge Injection

Test Circuits/Timing Diagrams (continued)

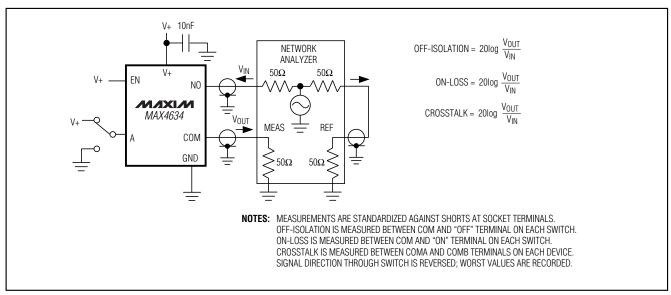


Figure 5. Off-Isolation/On-Channel Bandwidth

CHANNEL SELECT A1 MAX4634 N04 COM GND EN TMHz CAPACITANCE ANALYZER f = 1MHz

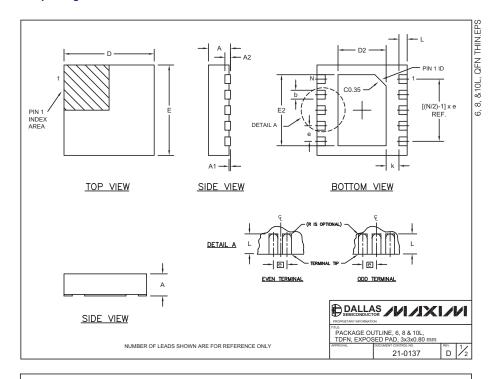
Figure 6. Channel Off/On-Capacitance

Chip Information

TRANSISTOR COUNT: 231

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.



JEDEC SPEC

MO229 / WEEA

1.50±0.10 2.30±0.10 0.50 BSC MO229 / WEED-3 0.25±0.05 2.00 REF

	COMMO	N DIME	NSIONS	1	
	SYMBOL	MIN.	MAX.	1	
	А	0.70	0.80	1	
	D	2.90	3.10	1	
	E	2.90	3.10	1	
	A1	0.00	0.05		
	L.	0.20	0.40		
	k	0.:	25 MIN.		
	A2	0.2	20 REF.		
PAC	CKAGE VAR	IATIONS	<u> </u>		
PKG	G. CODE	N	D2	E2	е
T63	3-1	6	1.50±0.10	2.30±0.10	0.95 BS0

T833-1

T1033-1

- NOTES:
 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
 2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
 3. WARPAGE SHALL NOT EXCEED 0.10 mm.
 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
 5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2".
 6. "N" IS THE TOTAL NUMBER OF LEADS.

1.50±0.10 2.30±0.10 0.65 BSC MO229 / WEEC

DALL SEMICONDU PROPRIETARY INFORM	AS /// //	KI /	
	DUTLINE, 6, 8 & 10L, DSED PAD, 3x3x0.80 r	nm	
I DEN, EXPO			

[(N/2)-1] x e

1.90 REF

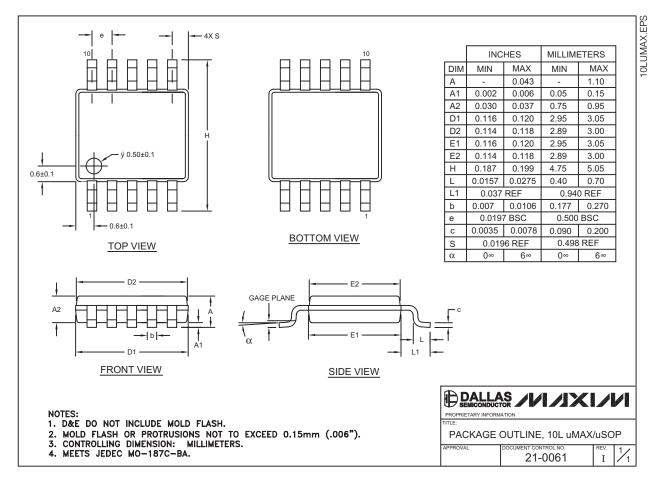
1.95 REF

0.40±0.05

0.30±0.05

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.



Note: The MAX4634 package does not have an exposed pad.

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